

# VUSK005R25BNA

**Datasheet** 





### VUSK005R25BNA

### **General Description**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)_max</sub>	$I_D$
	2.5Ω@10V	
30V	3.0Ω@4.5V	0.3A
	4.5Ω@2.5V	

# **Symbol**

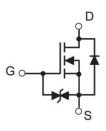


Figure 1 Symbol of VUSK005R25BNA

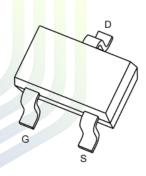
### **Features**

- $\blacksquare$  Excellent  $R_{DS(on)}$
- Trench Technology Power MOSFET
- Low Gate Charge
- ESD Protected

# **Application**

- DC/DC Converter
- Load Switch

# Package Type



**SOT-523** 

Figure 2 Package Type of VUSK005R25BNA

# **Ordering Information**

Product Name	Package		
VUSK005R25BNA	SOT-523		



### VUSK005R25BNA

# Absolute Maximum Ratings (T<sub>A</sub>= 25 °C, unless otherwise specified)

Parameter		Rating	Unit
Drain-Source Voltage	V <sub>DSS</sub>	50	V
Gate-Source Voltage	V <sub>GSS</sub>	±20	V
Continuous Drain Current <sup>Note1,4</sup>	$I_D$	0.3	A
Pulsed Drain Current <sup>Note2</sup>	$I_{DM}$	1.2	A
Total Power Dissipation Note4,5	P <sub>D</sub>	0.25	W
Junction Temperature	$T_{\rm J}$	150	°C
Storage Temperature	T <sub>STG</sub>	-55 to 150	°C

### **Thermal Resistance**

Par <mark>ameter                                   </mark>	Symbol	<mark>M</mark> in	Typ	Max	Unit
Thermal Resistance, Junction-to-Ambient <sup>Note5</sup>	$R_{ heta JA}$		5 <mark>00</mark>		°C/W





#### VUSK005R25BNA

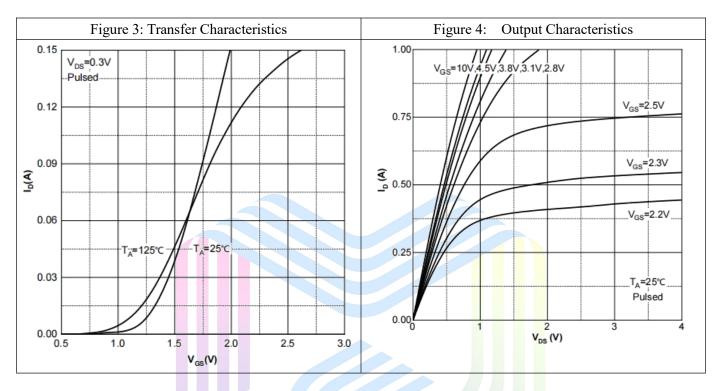
# Electrical Characteristics (T<sub>J</sub>= 25 °C, unless otherwise specified)

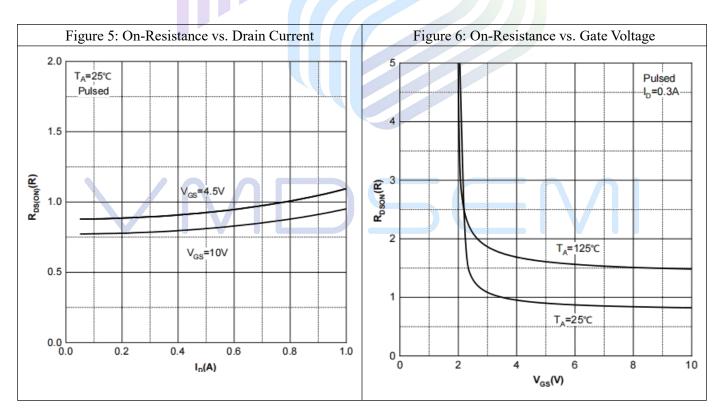
Parameter	Symbol	<b>Test Conditions</b>	Min	Тур	Max	Unit
Statistic Characteristics						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_{D}=250uA$	50			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}$ = 50V, $V_{GS}$ =0V			1	uA
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			±2	uA
Gate Threshold Voltage <sup>Note3</sup>	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_D=250uA$	0.6	0.9	1.5	V
		$V_{GS}=10V, I_{D}=0.3A$		0.92	2.5	Ω
Drain-source on-resistance <sup>Note3</sup>	R <sub>DS(on)</sub>	$V_{GS}$ =4.5V, $I_D$ = 0.2A		0.98	3	
		$V_{GS}$ = 2.5V, $I_D$ = 0.01A		1.2	4.5	
Dynamic Characteristics	Dynamic Characteristics					
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =15V		30		pF
Output Capacitance	Coss	V <sub>GS</sub> =0V		5.2		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>	f=1MHz		3.3		pF
Switching Parameters						
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD} = 5V$		15		
Turn-on Rise Time	$t_{\rm r}$	V <sub>GS</sub> =5V		35		ns
Turn-off Delay Time	$t_{ m d(off)}$	$R_L=500\Omega$		80		
Turn-off Fall Time	$t_{\mathrm{f}}$	$R_G=10\Omega$ , $I_D=10$ mA		80		
Source - Drain Diode Characteristics						
Diode Forward Voltage Note3	$ m V_{SD}$	$V_{GS} = 0V, I_S = 0.3A$			1.2	V

#### Notes:

- 1. The maximum current rating is limited by package.
- 2. Pulse Test : Pulse Width  $\leq 10\mu s$ , duty cycle  $\leq 1\%$ .
- 3. Pulse Test : Pulse Width  $\leq$  300 µs, duty cycle  $\leq$  2%.
- 4. The power dissipation  $P_D$  is limited by  $T_{J(MAX)} = 150$ °C.
- 5.Device mounted on  $1\text{in}^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_A$  =25°C.

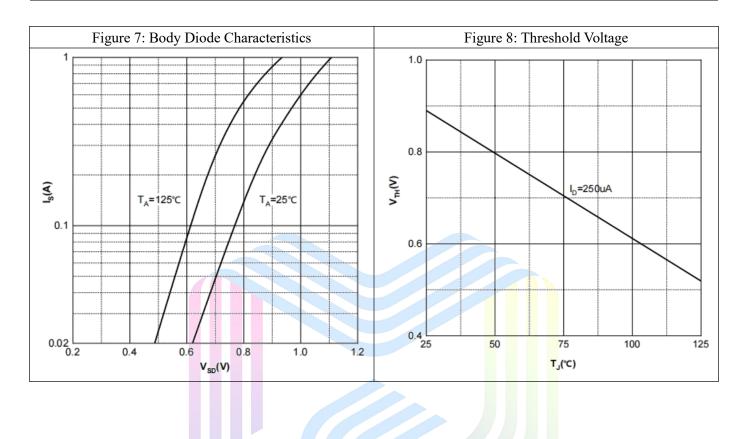
# **Typical Performance Characteristics**







### VUSK005R25BNA

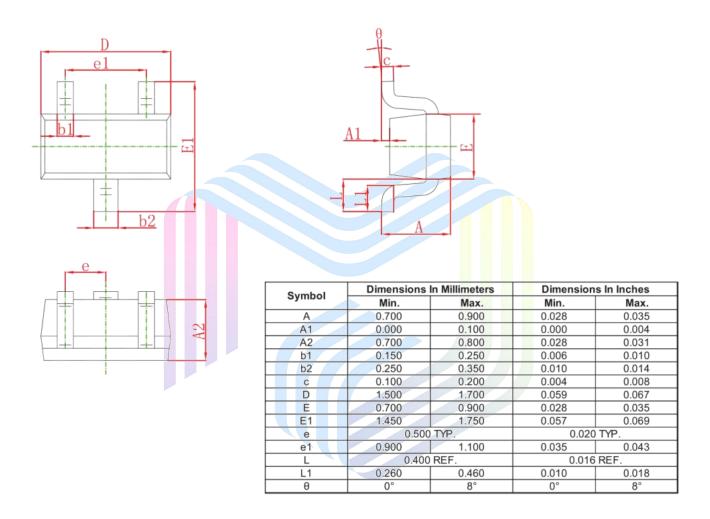




### VUSK005R25BNA

### **Mechanical Dimensions:**

**SOT-523 Package Information** 







#### 2.5Ω, 50V, N-Channel Power MOSFET

#### VUSK005R25BNA

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